

# Certificate

Standard **ISO 45001:2018**

Certificate Registr. No. 74 300 4879

Certificate Holder: **Micron Technology, Inc.**  
Post Office Box 6  
8000 S. Federal Way  
Boise ID 83707-0006  
USA

Scope: Design, Research and Development, Manufacture, Assembly and Test of Memory Components, Module and SSD Products

Proof has been furnished by means of an audit that the requirements of ISO 45001:2018 are met.

Validity: The certificate is valid from 2024-01-26 until 2027-01-25.  
First certification 2021

2024-01-30



TÜV Rheinland of North America, Inc.  
400 Beaver Brook Road  
Boxborough, MA 01719 United States

# Annex to certificate

Standard **ISO 45001:2018**

Certificate Registr. No. **74 300 4879**

No.	Location	Scope
/00	Micron Technology, Inc. Global EHS Post Office Box 6 8000 S. Federal Way Boise ID 83707-0006 USA	Central Function
/01	Micron Technology, Inc. 8000 S. Federal Way Boise ID 83707-0006 USA	Design, Research and Development of Semiconductor Memory Components
/02	Micron Technology, Inc. 9600 Godwin Drive Manassas VA 20110 USA	Manufacturing and Testing of Semiconductor Wafers
/04	Micron Semiconductor Asia Operations Pte. Ltd. 990 Bendemeer Road Singapore 339942 Singapore	Manufacturing and Testing of Memory Component, Module and SSD Products for Semiconductors
/05	Micron Semiconductor (Xi'an) Co., Ltd. No.28-2, Xin Xi Avenue, High- tech Industries Development Zone, Xi'an, 710119 Shaanxi P.R. China	Manufacturing and Testing of Semiconductor Components and Module Products

# Annex to certificate

Standard **ISO 45001:2018**

Certificate Registr. No. **74 300 4879**

/06	Micron Semiconductor Malaysia Sdn. Bhd. Tanjung Agas Industrial Area No K1-5, PLO 107 (PTD 6571) 84007 Muar, Johor Malaysia	Manufacturing and Testing of Semiconductor Components
/07	Micron Semiconductor Asia Operations Pte. Ltd. 1 Woodlands Industrial Park D Singapore-Street 1 738799 Singapore	Manufacturing of Semiconductor Wafers
/08	Micron Semiconductor Asia Operations Pte. Ltd. 1 Northcoast Drive Singapore 757432 Singapore	Research and Development, Manufacturing and Testing of Semiconductor Wafers
/09	Micron Memory Taiwan Co., Ltd. No. 369, Sec 4, Sanfong Road Taichung City TWN 42152 Taiwan, R.O.C.	Manufacturing and Testing of Semiconductor Wafers
/11	Micron Memory Japan, K.K. 7-10 Yoshikawa Kogyo Danchi Higashi Hiroshima-shi Hiroshima, Hiroshima-ken 739-0198 Japan	Research and Development, Manufacturing and Testing of Semiconductor Wafers

# Annex to certificate

Standard **ISO 45001:2018**

Certificate Registr. No. **74 300 4879**

- /12 Micron Technology Taiwan, Inc. Manufacturing of Semiconductor Wafers  
No.667, Fuxing 3rd Rd.  
Hwa-Ya Technology Park  
Taoyuan City 333  
Taiwan, R.O.C.
- /13 Micron Memory Taiwan Co., Ltd. (MTB) Manufacturing and Testing of Semiconductor Module Products  
No. 88 and 88-1 Houke S. Rd.  
Houli Dist.  
Taichung City 42152  
Taiwan, R.O.C.
- /15 Micron Memory Malaysia Sdn Bhd Manufacturing and Testing of Semiconductor Module and SSD Products  
No. 1063, Plot 19  
Tingkat Perusahaan 6  
Prai Industrial Estate  
13600 Prai, Penang  
Malaysia
- /16 Micron Memory Malaysia Sdn Bhd. Manufacturing and Testing of Semiconductor Module, SSD Products and Component Assembly  
Taman Perindustrian Batu Kawan  
Mukim 13, Seberang Perai Selatan  
PMT 779, Lingkaran Cassia Selatan  
Penang  
14100 Bandar Cassia  
Malaysia

# Annex to certificate

Standard **ISO 45001:2018**

Certificate Registr. No. **74 300 4879**

/17 Micron Semiconductor Malaysia Manufacturing and Testing of Semiconductor  
Sdn. Bhd. Components  
K93 (PLO 74), Jalan  
Perindustrian 7  
Tanjung Agas Industrial Area  
External Warehouse (Golden  
Sands II)  
84007 Tangkak  
Malaysia

/18 Micron Memory Taiwan Co., Administration  
Ltd.  
No. 306, Sec. 2, Houke Rd.  
Houli District  
Taichung City 42152  
Taiwan, R.O.C.

2024-01-30



TÜV Rheinland of North America, Inc.  
400 Beaver Brook Road  
Boxborough, MA 01719 United States